

Customer No. 23932

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Takuya Yamamoto et al.

Serial No. Unassigned

Filed: May 15, 2001

Title: Method For Manufacturing
Printed Wiring Board

Attorney Docket No. 47163-00037

Group Art No. Unassigned

Examiner: Unassigned

CERTIFICATE OF MAILING

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Deborah Ricks
Deborah Ricks

PRELIMINARY AMENDMENT

ASSISTANT COMMISSIONER FOR PATENTS

Washington, D.C. 20231

Attention: Box Patent Application

Dear Sir:

Before examining the subject application, please enter the following amendments:

In the Specification:

Please replace the entire specification with the attached new specification.

In the Claims

Please enter new claim 4.

4. (New) A method for manufacturing a printed wiring board according to claim 3, wherein each of the waved copper foils has a surface roughness (Rz) of 10 to 20µm.